



BUW42/42P/42PFI
BUW42A/42AP/42APFI

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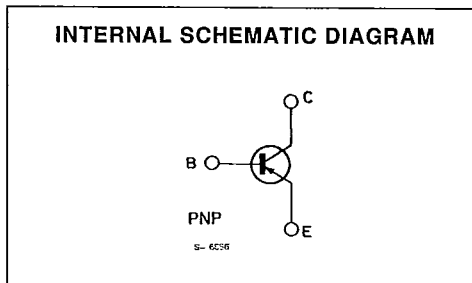
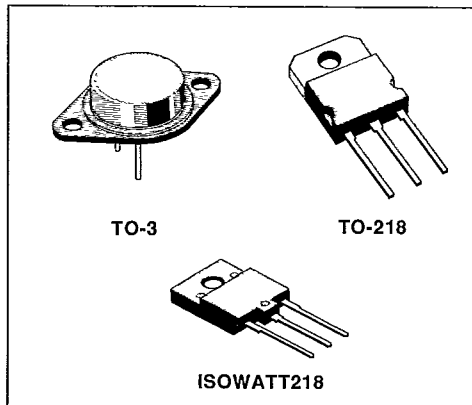
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HIGH VOLTAGE POWER SWITCH

DESCRIPTION

The BUW42/A, BUW42P/42AP and BUW42PFI/APFI are silicon multiepitaxial mesa PNP transistors mounted respectively in TO-3 metal case, TO-218 plastic package and ISOWATT218 fully isolated package.

They are intended in fast switching applications for high output power.



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	BUW			Unit
		42/P/PFI	42A/AP/APFI		
V_{CES}	Collector-emitter Voltage ($V_{BE} = 0$)	- 400	- 450		V
V_{CEO}	Collector-emitter Voltage ($I_B = 0$)	- 350	- 400		V
V_{EBO}	Emitter-base Voltage ($I_C = 0$)	- 7			V
I_C	Collector Current	- 15			A
I_{CM}	Collector Peak Current	- 30			A
I_B	Base Current	- 10			A
		TO-3	TO-218	ISOWATT218	
P_{tot}	Total Dissipation at $T_c < 25^\circ C$	150	105	65	W
T_{stg}	Storage Temperature	- 65 to 175	- 65 to 150	- 65 to 150	$^\circ C$
T_j	Max. Operating Junction Temperature	175	150	150	$^\circ C$

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Thermal Data

$R_{th J-case}$	Thermal Resistance Junction-case	Max	TO-3	SOT-93	ISOWATT218	Unit
			1.2	1.2	1.92	°C/W

ELECTRICAL CHARACTERISTICS ($T_{case} = 25^{\circ}C$ unless otherwise specified)

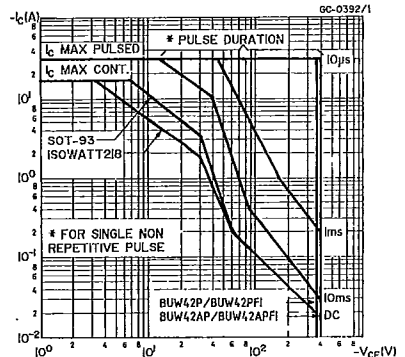
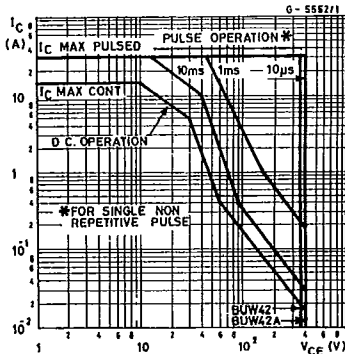
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Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector Cutoff Current ($V_{BE} = 0$)	$V_{CE} = -400V$ for BUW42/P/PFI $V_{CE} = -450V$ for BUW42A/AP/APFI			-1	mA
I_{EBO}	Emitter Cutoff Current	$V_{EB} = -5V$ for BUW42/P/PFI $V_{EB} = -7V$ for BUW42A/AP/APFI			-1	mA
$V_{CE0(sus)}^*$	Collector-emitter Sustaining Voltage ($I_B = 0$)	$I_C = -100mA$ for BUW42/P/PFI for BUW42A/AP/APFI	-350 -400			V V
$V_{CE(sat)}^*$	Collector-emitter Saturation Voltage	$I_C = -10A$ $I_B = -3A$			-1.5	V
$V_{BE(sat)}^*$	Base-emitter Saturation Voltage	$I_C = -10A$ $I_B = -3A$			-2	V
h_{FE}^*	DC Current Gain	$I_C = -3A$ $V_{CE} = -5V$	12		80	
t_{on} t_s t_f	RESISTIVE LOAD Turn-on Time Storage Time Fall Time	$V_{CC} = -250V$ $I_C = -10A$ $I_{B1} = -I_{B2} = -3.3A$		0.3 0.5 0.3	0.6 1.5 0.6	μs μs μs

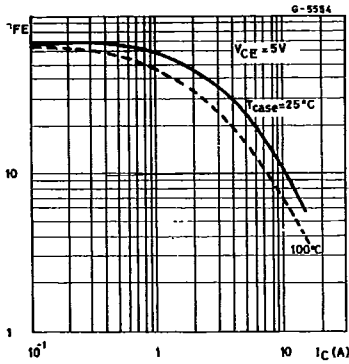
* Pulsed : pulse duration = 300 μs , duty cycle = 1.5 %.

Safe Operating Areas.
(TO-3).

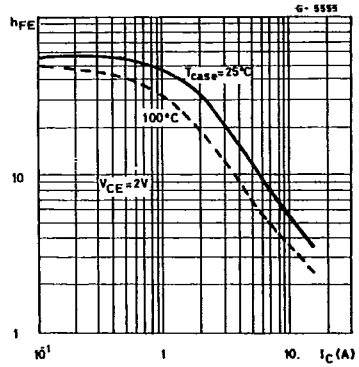
Safe Operating Areas.
(TO-218, ISOWATT218).



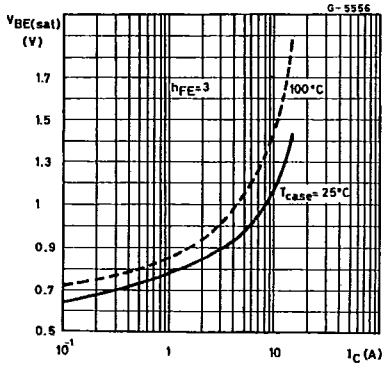
DC Current Gain.



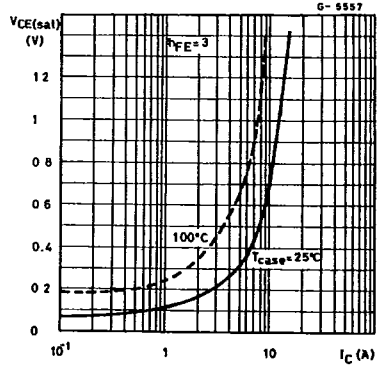
DC Current Gain.



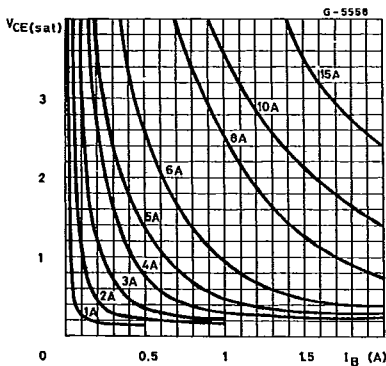
Base-emitter Saturation Voltage.



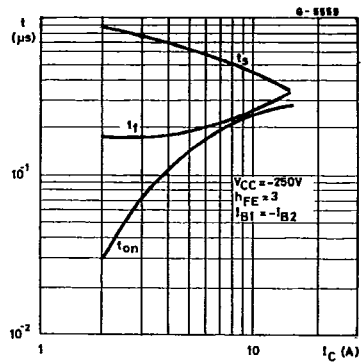
Collector-emitter Saturation Voltage.



Collector-emitter Saturation Voltage.



Saturated Switching-times Resistive Load.

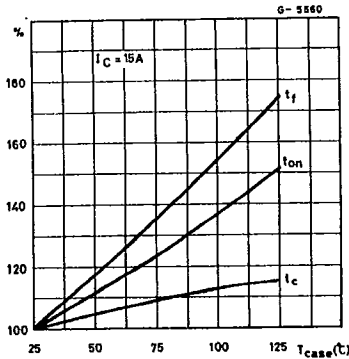


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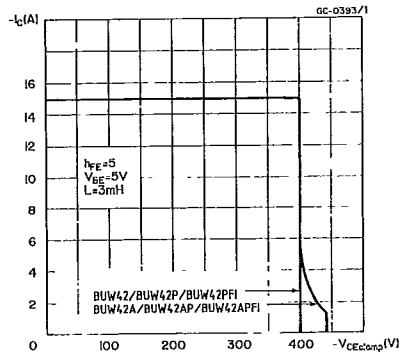
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Switching Times Percentage Variation vs. T_{case}
Resistive Load.



Clamped Reverse Bias Safe Operating Areas.



ISOWATT218 PACKAGE CHARACTERISTICS AND APPLICATION.

ISOWATT218 is fully isolated to 4000V dc. Its thermal impedance, given in the data sheet, is optimized to give efficient thermal conduction together with excellent electrical isolation. The structure of the case ensures optimum distances between the pins and heatsink. These distances are in agreement with VDE and UL creepage and clearance standards. The ISOWATT218 package eliminates the need for external isolation so reducing fixing hardware.

The package is supplied with leads longer than the standard TO-218 to allow easy mounting on pcbs. Accurate moulding techniques used in manufacture

assures consistent heat spreader-to-heatsink capacitance.

ISOWATT218 thermal performance is equivalent to that of the standard part, mounted with a 0.1 mm mica washer. The thermally conductive plastic has a higher breakdown rating and is less fragile than mica or plastic sheets. Power derating for ISOWATT218 packages is determined by :

$$P_D = \frac{T_j - T_c}{R_{th}}$$

THERMAL IMPEDANCE OF ISOWATT218 PACKAGE

Figure 3 illustrates the elements contributing to the thermal resistance of a transistor heatsink assembly, using ISOWATT218 package.

The total thermal resistance $R_{th(tot)}$ is the sum of each of these elements. The transient thermal impedance, Z_{th} for different pulse durations can be estimated as follows :

- 1-For a short duration power pulse of less than 1 ms :
 $Z_{th} < R_{thJ-C}$
- 2 - For an intermediate power pulse of 5ms to 50ms seconds :

$$Z_{th} = R_{thJ-C}$$

- 3 - For long power pulses of the order of 500ms seconds or greater :

$$Z_{th} = R_{thJ-C} + R_{thC-HS} + R_{thHS-amb}$$

It is often possible to discern these areas on transient thermal impedance curves.

Figure 3.

